ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® INDUSTRIES® INTERNATIONAL AND ADDRESS	L Bannockb	ourn, Illinois, A	Il rights reserved untions.	under both	This docum level parts, t	ent is a declarat he declaration of	ion of the su	ibstances s all lowe	within the manufactu er level materials for w	rer listed	item. Note: i manufacture	f the item is an as r has engineering	ssembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Forr http://www.ipc.org/IPC-175x Dist				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials an				ials and N	and Mfg Information				
Supplier Information														
Company name* Compa			ompany unique ID			Unique ID Authority				Respon	Response Date*			
onsemi								2025-06-07						
Contact Name Title - Contact			ct	Ph			Phone - Contact*				Email - Contact*			
Product-Env-Stewards Product Envi			wiro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Represe			sentative		Phone - Representative*			Email - Representative*						
Product-Env-Stewards Product Enviro			ro Compliance		NA			Product-Env-Stewards@onsemi.com						
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version]	Manufacturing Site		Weight*	UOM	Unit Type	
	MC14514	4BDWR2G	LOG CMOS LATCH/DCODE 4BT		ВТ	2025-06-07]	PH1		661.78	mg	Each	
Manufacturing Proccess Information	on													
Terminal Plating / Grid Array Mate	Material Terminal Base		Alloy J	oy J-STD-020 MSL Rat		Peak Proc	Peak Process Body Temperatu		re Max Time at Peak	Tempera	ture Numb	per of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Alloy			3		260		С	30	seco	nds 3				
Comments														
ATTENTION: MSL 3 Rated item requires I	Bake and D	ry Pack (after	electrical test)											
for more information regarding material co	mposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	inition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead cury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.79	mg	Supplier	Silicon (Si)	7440-21-3		3.79	mg
Die Attach	24.58	mg	Supplier	Silver (Ag)	7440-22-4		18.435	mg
			Supplier	Epoxy resins	129915-35-1		6.145	mg
Lead Frame 3	385.08	mg	Supplier	Silver (Ag)	7440-22-4		2.6956	mg
			Supplier	Zinc (Zn)	7440-66-6		0.4621	mg
			Supplier	Iron (Fe)	7439-89-6		9.0494	mg
			Supplier	Copper (Cu)	7440-50-8		372.7574	mg
			Supplier	Phosphorus (P)	7723-14-0		0.1155	mg
Mold Compound-Black	242.16	mg		Epoxy Phenol Resin	proprietary data		25.4268	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		216.7332	mg
Plating	5.6	mg	Supplier	Tin (Sn)	7440-31-5		5.6	mg
Wire Bond - Cu	0.57	mg	Supplier	Copper (Cu)	7440-50-8		0.57	mg